



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kie Y. Ahn et al.

Title: SELECTIVE ELECTROLESS-PLATED COPPER METALLIZATION

Docket No.: 303.672US1

Serial No.: 09/483,881

Filed: January 18, 2000

Due Date: February 8, 2007

Examiner: Kyoung Lee

Group Art Unit: 2812

Customer No.: 21186

Confirmation No.: 8976

Commissioner for Patents

Notice of Allowance Date:

Attn: MAIL STOP ISSUE FEE

November 8, 2006

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the attached:

- Authorization to charge Deposit Account 19-0743 in the amount of \$1400.00 to cover the Large Entity Issue Fee Payment.
- Issue Fee Transmittal (Form PTOL-85).
- Communication Re: Fee Address (1 page).
- Amendment Under 37 C.F.R. § 1.312 (11 pages).
- A return postcard.

Please charge any additional required fees for the Issue Fee Payment or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

By _____

Timothy B. Clise
Reg. No. 40,957
TBC/cmb

Customer Number: 21186

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Attn – MAIL STOP ISSUE FEE, P.O. Box 1450, Alexandria, VA 22313-1450, on this 8 day of February, 2007.

CB/MB
Name _____

CB/MB
Signature _____